



	PLA192	Units
Load Voltage	600	V
Load Current	150	mA
Max R _{ON}	22	Ω

Features

- 5000V_{RMS} Input/Output Isolation
- Small 6 Pin DIP Package
- Low Drive Power Requirements (TTL/CMOS Compatible)
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Machine Insertable, Wave Solderable
- 600 volt blocking

Applications

- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
 - Meters (Watt-Hour, Water, Gas)
- Medical Equipment—Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

Description

The PLA192 is a 1-Form-A solid state relay that uses optically coupled relay technology to provide an enhanced 5000V isolation barrier between the input and output of the relay. The efficient MOSFET switches use Clares patented OptoMOS® architecture. The optically coupled input is controlled by a highly efficient GaAlAs infrared LED.

Approvals

- UL Approved to UL1577
- CSA Certified
- Complies with EN60950

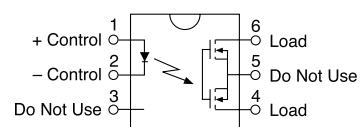
Ordering Information

Part #	Description
PLA192	6 Pin Dip (50/Tube)
PLA192S	6 Pin Surface Mount (50/Tube)
PLA192STR	6 Pin Surface Mount (1000/Reel)

Pin Configuration

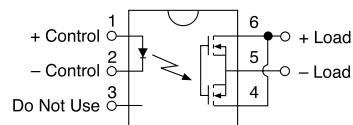
PLA192 Pinout

AC/DC Configuration

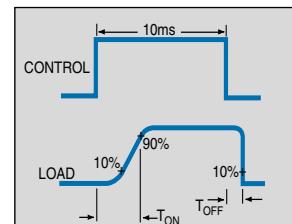


PLA192 Pinout

DC Only Configuration



Switching Characteristics of Normally Open (Form A) Devices



Absolute Maximum Ratings (@ 25° C)

Parameter	Min	Typ	Max	Units
Input Power Dissipation	-	-	150 ¹	mW
Input Control Current	-	-	50	mA
Peak (10ms)	-	-	1	A
Reverse Input Voltage	-	-	5	V
Total Power Dissipation	-	-	800 ²	mW
Peak Blocking Voltage	-	-	600	V
Isolation Voltage				
Input to Output (60 seconds)	5000	-	-	V _{RMS}
Operational Temperature	-40	-	+85	°C
Storage Temperature	-40	-	+125	°C
Soldering Temperature DIP Package	-	-	+260	°C
Surface Mount Package (10 Seconds Max.)	-	-	+220	°C

¹ Derate Linearly 1.33 mw/°C² Derate Linearly 6.67 mw/°C

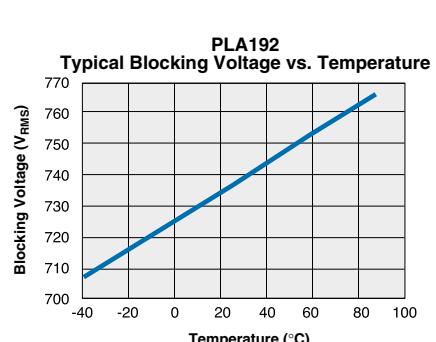
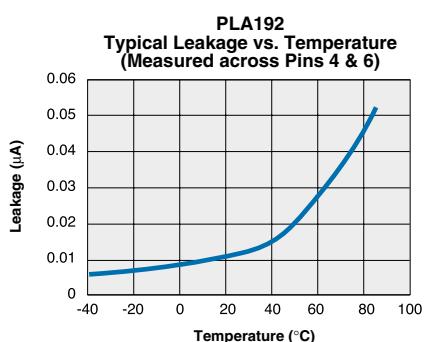
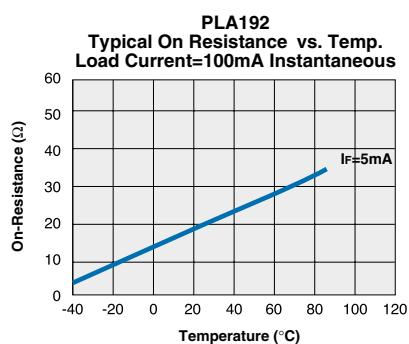
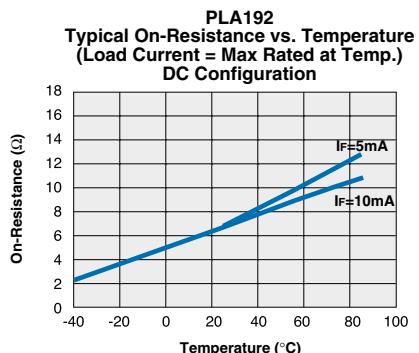
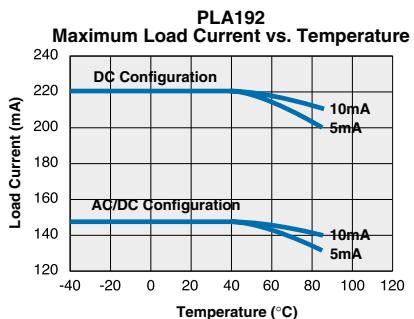
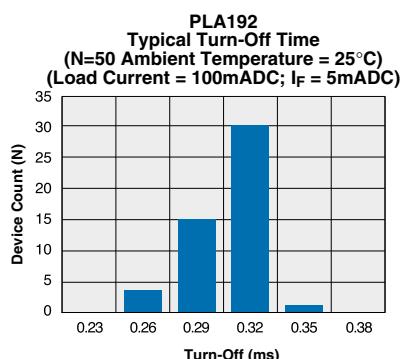
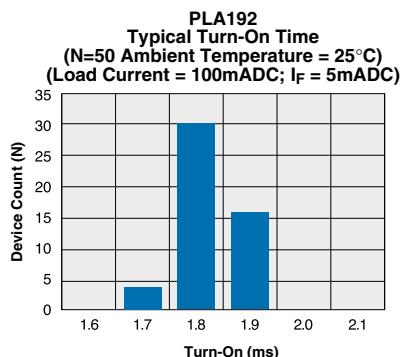
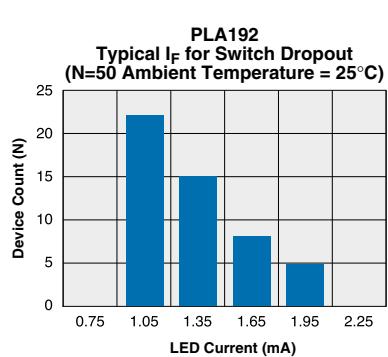
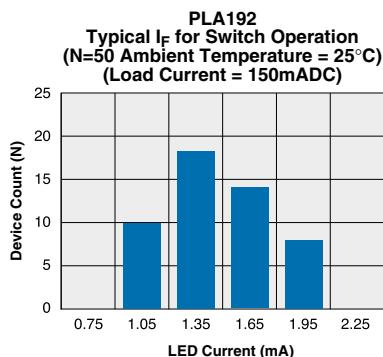
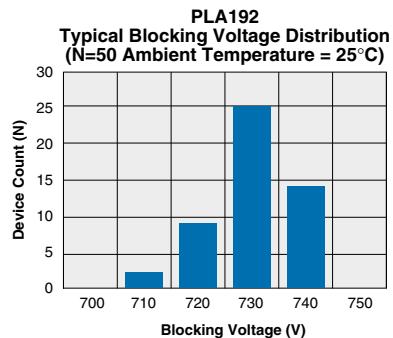
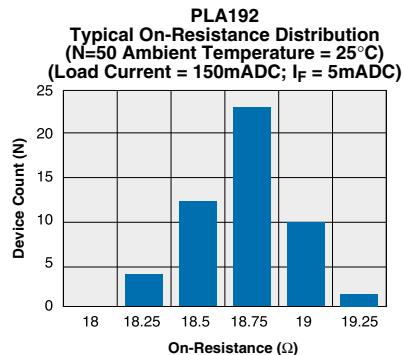
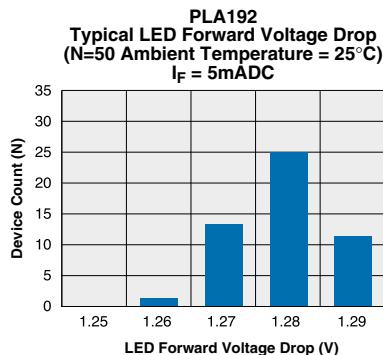
Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Electrical Characteristics

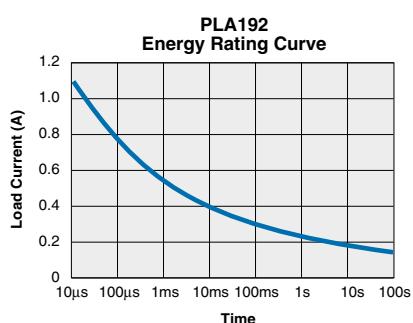
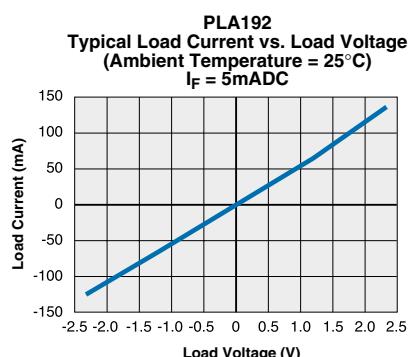
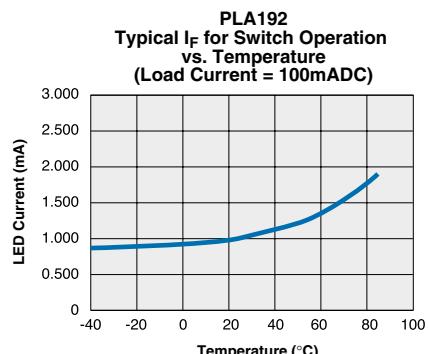
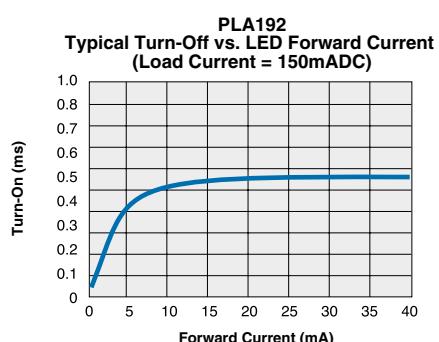
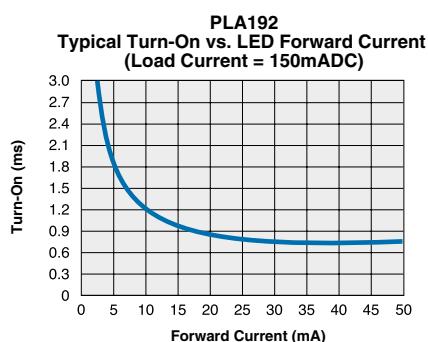
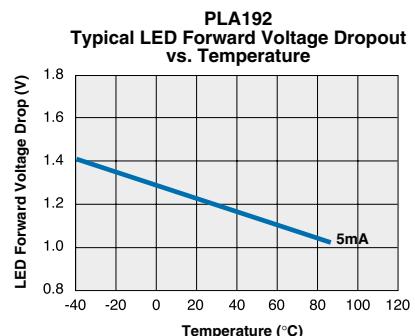
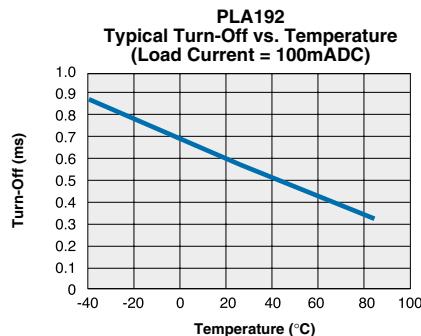
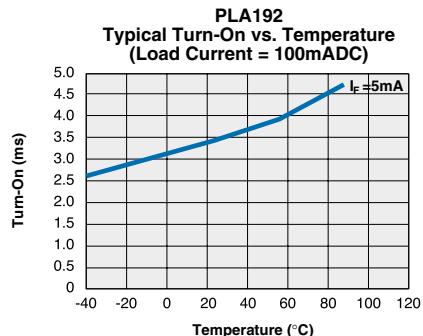
Parameter	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics @ 25°C						
Load Current (Continuous) AC/DC Configuration	-	I _L	-	-	150	mA
DC Configuration	-	I _L	-	-	220	mA
Peak Load Current	10ms	I _{LPK}	-	-	350	mA
On-Resistance*						
AC/DC Configuration	I _L =150mA	R _{ON}	-	-	22	Ω
DC Configuration	I _L =220mA		-	-	8	Ω
Off-State Leakage Current	V _L =600V	I _{LEAK}	-	-	1	μA
Switching Speeds						
Turn-On	I _F =5mA, V _L =10V	T _{ON}	-	-	5	ms
Turn-Off	I _F =5mA, V _L =10V	T _{OFF}	-	-	5	ms
Output Capacitance	50V; f=1MHz	C _{OUT}	-	50	-	pF
Input Characteristics @ 25°C						
Input Control Current	I _L =100mA	I _F	5	-	50	mA
Input Dropout Current	-	I _F	0.4	0.7	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Reverse Input Voltage	-	V _R	-	-	5	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μA
Common Characteristics @ 25°C						
Input to Output Capacitance	-	C _{I/O}	-	3	-	pF

* Within 1 second of on time

PERFORMANCE DATA*



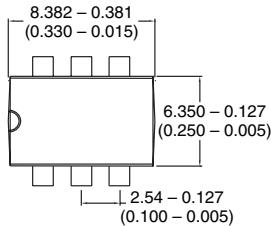
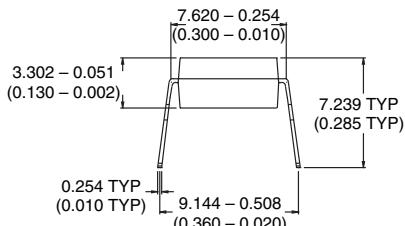
*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

PERFORMANCE DATA*


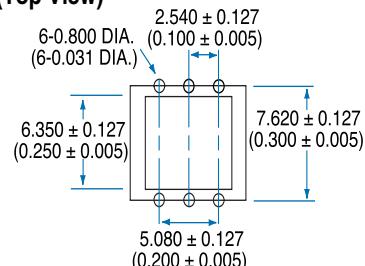
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MECHANICAL DIMENSIONS

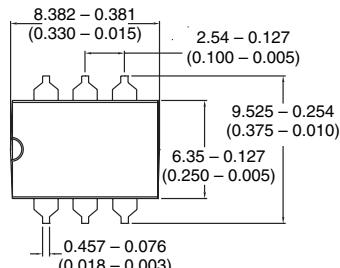
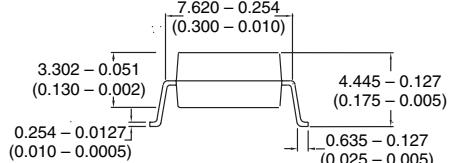
6Pin DIP Through Hole (Standard)



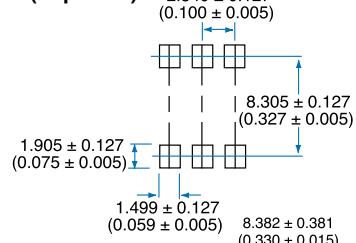
PC Board Pattern (Top View)



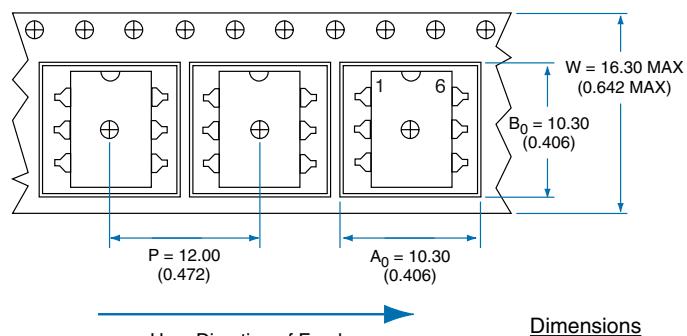
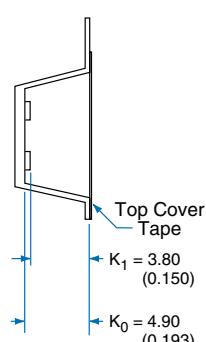
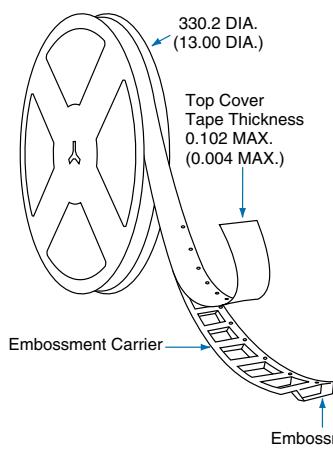
6Pin DIP Surface Mount ("S" Suffix)



PC Board Pattern (Top View)



Tape and Reel Packaging for 6 Pin Power DIP Surface Mount Package



Dimensions
mm
(inches)

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